

## STP78N75F4

# N-channel 75 V, 0.0092 Ω typ., 78 A STripFET™ DeepGATE™ Power MOSFET in TO-220 package

Datasheet — production data

#### **Features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STP78N75F4	75 V	< 0.011 Ω	78 A

- N-channel enhancement mode
- 100% avalanched rated
- Low gate charge
- Very low on-resistance

#### **Application**

■ Switching applications

### **Description**

This device is an N-channel Power MOSFET developed using ST's STripFET™ DeepGATE™ technology. The device has a new gate structure and is specially designed to minimize on-state resistance to provide superior switching performance.

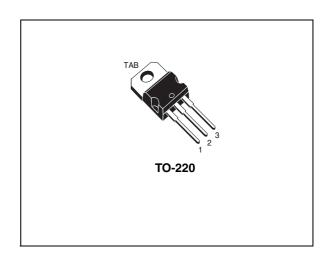


Figure 1. Internal schematic diagram

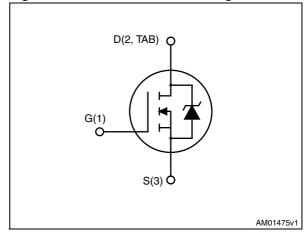


Table 1. Device summary

Order codes	Marking	Package	Packaging
STP78N75F4	78N75F4	TO-220	Tube

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STP78N75F4 Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	75	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	78	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	55	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	312	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	150	W
	Derating factor	1	W/°C
E <sub>AS</sub> (2)	Single pulse avalanche energy	185	mJ
T <sub>stg</sub>	Storage temperature	– 55 to 175	°C
Tj	Operating junction temperature	- 55 10 175	

<sup>1.</sup> Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	1	°C/W
R <sub>thj-a</sub>	R <sub>thj-a</sub> Thermal resistance junction-ambient max		°C/W

<sup>2.</sup> Starting  $T_i = 25$  °C,  $I_D = 35$  A,  $V_{DD} = 50$  V

## 2 Electrical characteristics

(T<sub>CASE</sub> = 25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source Breakdown voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0	75			V
1	Zero gate voltage	V <sub>DS</sub> = 75 V			1	μΑ
I <sub>DSS</sub> Drain cur	Drain current (V <sub>GS</sub> = 0)	$V_{DS} = 75 \text{ V,T}_{C} = 125 \text{ °C}$			100	μΑ
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 20 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2		4	٧
R <sub>DS(on)</sub>	Static drain-source on- resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 39 A		0.0092	0.011	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance			5015		pF
C <sub>oss</sub>	Output capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$	-	382	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	V <sub>GS</sub> = 0		218		pF
$Q_g$	Total gate charge	V <sub>DD</sub> = 37.5 V, I <sub>D</sub> = 78 A,		76		nC
$Q_{gs}$	Gate-source charge	$V_{DD} = 37.5 \text{ V}, I_D = 78 \text{ A},$ $V_{GS} = 10 \text{ V}$	-	23	-	nC
$Q_{gd}$	Gate-drain charge	(see Figure 14)		18.5		nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time Rise time	$V_{DD} = 37.5 \text{ V}, I_{D} = 39 \text{ A}$ $R_{G} = 4.7 \Omega V_{GS} = 10 \text{ V}$	-	25 33	-	ns ns
t <sub>d(off)</sub>	Turn-off-delay time Fall time	(see Figure 13)	-	61 14	-	ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current		-		78	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		312	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$I_{SD} = 78 \text{ A}, V_{GS} = 0$	-		1.5	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 78 \text{ A}, V_{DD} = 60 \text{ V}$ di/dt = 100 A/ $\mu$ s, $T_j = 150 ^{\circ}\text{C}$ (see Figure 15)	-	67 183 5.5		ns nC A

<sup>1.</sup> Pulse width limited by safe operating area.

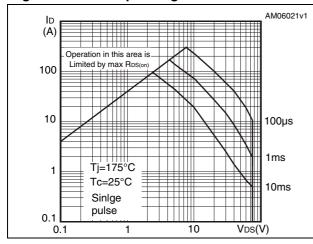
<sup>2.</sup> Pulsed: Pulse duration =  $300 \mu s$ , duty cycle 1.5%

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### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance



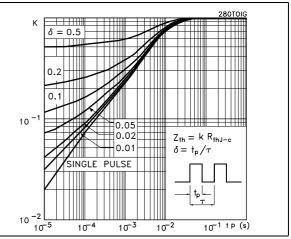
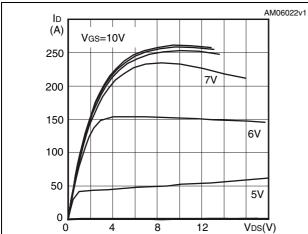


Figure 4. Output characteristics

Figure 5. Transfer characteristics



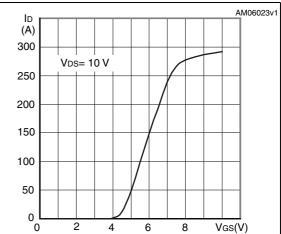
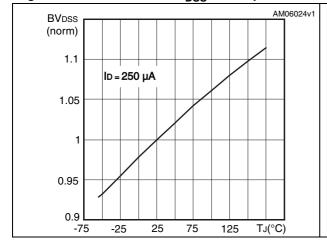
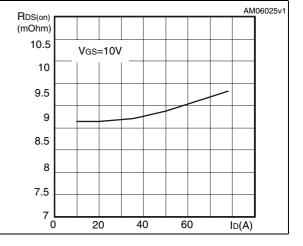


Figure 6. Normalized BV<sub>DSS</sub> vs temperature

Figure 7. Static drain-source on-resistance





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AM06026v1 AM06027v1 Vgs (pF) (V) VDD=37.5V 6100 12 ID=78A 5100 10 Ciss 4100 8 3100 6 2100 4 Crss 1100 2 Coss 100 20 40 60 80 Qg(nC) 20 40 60 V<sub>DS</sub>(V) 0

Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

Figure 10. Normalized on-resistance vs temperature

Figure 11. Normalized gate threshold voltage vs temperature

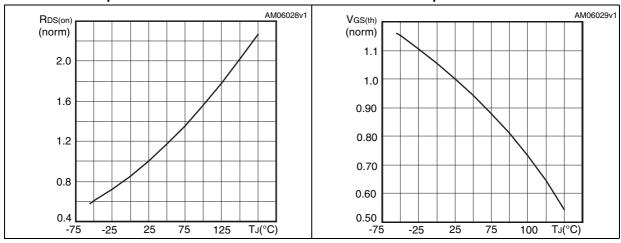
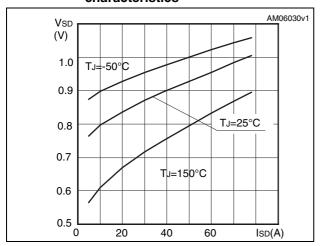


Figure 12. Source-drain diode forward characteristics



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Test circuits STP78N75F4

## 3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

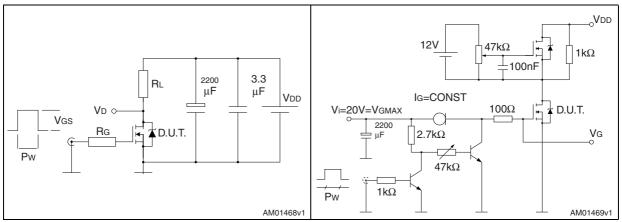


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

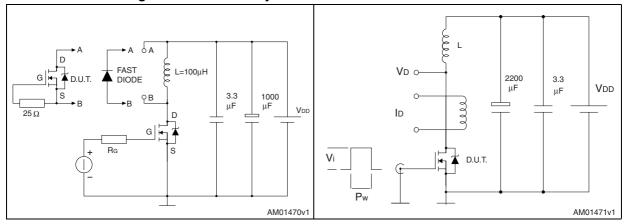
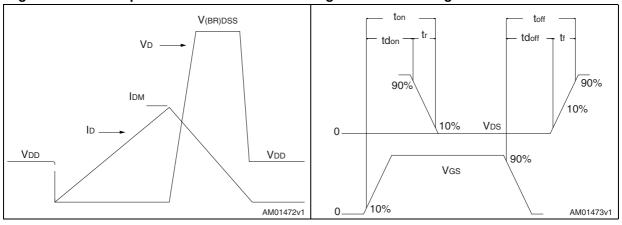


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



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# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 8. TO-220 type A mechanical data

		mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95



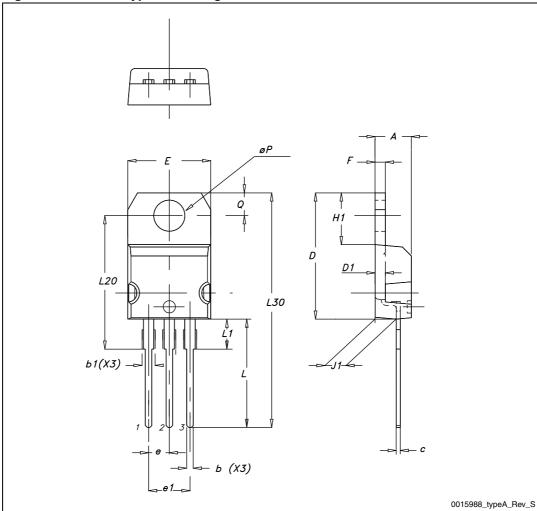


Figure 19. TO-220 type A drawing

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STP78N75F4 Revision history

# 5 Revision history

Table 9. Document revision history

Date	Revision	Changes
12-May-2009	1	First release.
26-Nov-2009	2	Document status promoted from preliminary data to datasheet (see Section 2.1: Electrical characteristics (curves)).
24-Jul-2012	3	Minor text changes on the cover page. Updated Section 4: Package mechanical data.

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